



**THE DATASHEET OF
FDMC86520L**





ON Semiconductor®

FDMC86520L

N-Channel Power Trench® MOSFET 60 V, 22 A, 7.9 mΩ

Features

- Max $r_{DS(on)}$ = 7.9 mΩ at $V_{GS} = 10$ V, $I_D = 13.5$ A
- Max $r_{DS(on)}$ = 11.7 mΩ at $V_{GS} = 4.5$ V, $I_D = 11.5$ A
- Low Profile - 1 mm max in Power 33
- 100% UIL Tested
- RoHS Compliant

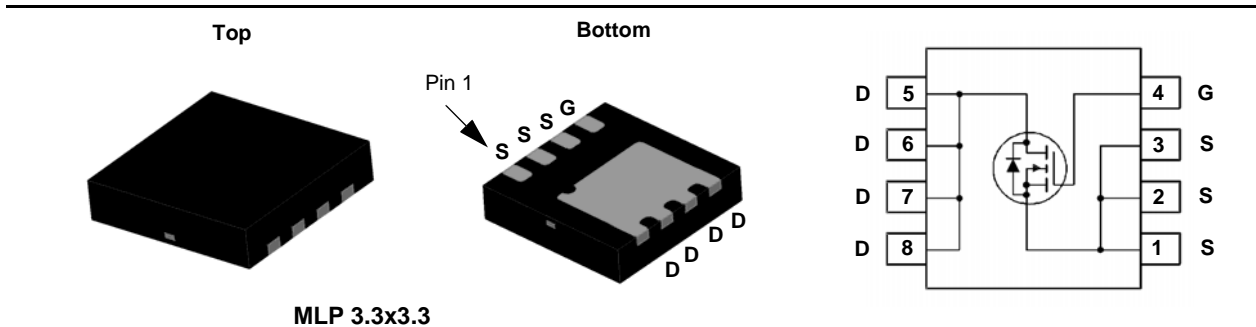


General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$, fast switching speed and body diode reverse recovery performance.

Applications

- Primary Switch in isolated DC-DC
- Synchronous Rectifier
- Load Switch



MLP 3.3x3.3

MOSFET Maximum Ratings $T_A = 25$ °C unless otherwise noted

| Symbol | Parameter | Ratings | Units | |
|----------------|--|-------------------------|-------|------|
| V_{DS} | Drain to Source Voltage | 60 | V | |
| V_{GS} | Gate to Source Voltage | ±20 | V | |
| I_D | Drain Current -Continuous | $T_C = 25$ °C | A | |
| | -Continuous | $T_A = 25$ °C (Note 1a) | | 13.5 |
| | -Pulsed | | | 60 |
| E_{AS} | Single Pulse Avalanche Energy | (Note 3) | 79 mJ | |
| P_D | Power Dissipation | $T_C = 25$ °C | 40 W | |
| | Power Dissipation | $T_A = 25$ °C (Note 1a) | 2.3 | |
| T_J, T_{STG} | Operating and Storage Junction Temperature Range | -55 to +150 | °C | |

Thermal Characteristics

| | | | |
|-----------------|---|-----|------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | 3.1 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient (Note 1a) | 53 | |

Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|------------|----------|-----------|------------|------------|
| FDMC86520L | FDMC86520L | Power 33 | 13 " | 12 mm | 3000 units |

Electrical Characteristics $T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Units |
|--------|-----------|-----------------|-----|-----|-----|-------|
|--------|-----------|-----------------|-----|-----|-----|-------|

Off Characteristics

| | | | | | | |
|--------------------------------------|---|---|----|----|-----------|----------------------|
| BV_{DSS} | Drain to Source Breakdown Voltage | $I_D = 250\text{ }\mu\text{A}$, $V_{GS} = 0\text{ V}$ | 60 | | | V |
| $\frac{\Delta BV_{DSS}}{\Delta T_J}$ | Breakdown Voltage Temperature Coefficient | $I_D = 250\text{ }\mu\text{A}$, referenced to $25\text{ }^\circ\text{C}$ | | 29 | | mV/ $^\circ\text{C}$ |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 48\text{ V}$, $V_{GS} = 0\text{ V}$ | | | 1 | μA |
| I_{GSS} | Gate to Source Leakage Current | $V_{GS} = \pm 20\text{ V}$, $V_{DS} = 0\text{ V}$ | | | ± 100 | nA |

On Characteristics

| | | | | | | |
|--|--|--|---|-----|------|----------------------|
| $V_{GS(th)}$ | Gate to Source Threshold Voltage | $V_{GS} = V_{DS}$, $I_D = 250\text{ }\mu\text{A}$ | 1 | 1.7 | 3 | V |
| $\frac{\Delta V_{GS(th)}}{\Delta T_J}$ | Gate to Source Threshold Voltage Temperature Coefficient | $I_D = 250\text{ }\mu\text{A}$, referenced to $25\text{ }^\circ\text{C}$ | | -7 | | mV/ $^\circ\text{C}$ |
| $r_{DS(on)}$ | Static Drain to Source On Resistance | $V_{GS} = 10\text{ V}$, $I_D = 13.5\text{ A}$ | | 6.5 | 7.9 | m Ω |
| | | $V_{GS} = 4.5\text{ V}$, $I_D = 11.5\text{ A}$ | | 9.1 | 11.7 | |
| | | $V_{GS} = 10\text{ V}$, $I_D = 13.5\text{ A}$, $T_J = 125\text{ }^\circ\text{C}$ | | 9 | 11 | |
| g_{FS} | Forward Transconductance | $V_{DS} = 5\text{ V}$, $I_D = 13.5\text{ A}$ | | 49 | | S |

Dynamic Characteristics

| | | | | | | |
|-----------|------------------------------|--|--|------|------|----------|
| C_{iss} | Input Capacitance | $V_{DS} = 30\text{ V}$, $V_{GS} = 0\text{ V}$, $f = 1\text{ MHz}$ | | 3420 | 4550 | pF |
| C_{oss} | Output Capacitance | | | 638 | 850 | pF |
| C_{rss} | Reverse Transfer Capacitance | | | 25 | 40 | pF |
| R_g | Gate Resistance | | | 0.5 | | Ω |

Switching Characteristics

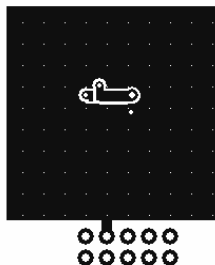
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|--------------|-------------------------------|--|---|-----|-----|----|----|
| $t_{d(on)}$ | Turn-On Delay Time | $V_{DD} = 30\text{ V}$, $I_D = 13.5\text{ A}$, $V_{GS} = 10\text{ V}$, $R_{GEN} = 6\text{ }\Omega$ | | 15 | 30 | ns | |
| t_r | Rise Time | | | 5.2 | 10 | ns | |
| $t_{d(off)}$ | Turn-Off Delay Time | | | 32 | 55 | ns | |
| t_f | Fall Time | | | 3.4 | 10 | ns | |
| $Q_{g(TOT)}$ | Total Gate Charge | | $V_{GS} = 0\text{ V to } 10\text{ V}$ | | 45 | 64 | nC |
| $Q_{g(TOT)}$ | Total Gate Charge | $V_{GS} = 0\text{ V to } 4.5\text{ V}$ | $V_{DD} = 30\text{ V}$, $I_D = 13.5\text{ A}$ | | 21 | 30 | nC |
| Q_{gs} | Total Gate Charge | | | | 9.6 | | nC |
| Q_{gd} | Gate to Drain "Miller" Charge | | | | 4.9 | | nC |

Drain-Source Diode Characteristics

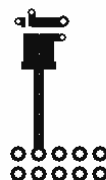
| | | | | | | |
|----------|---------------------------------------|--|--|------|-----|----|
| V_{SD} | Source to Drain Diode Forward Voltage | $V_{GS} = 0\text{ V}$, $I_S = 13.5\text{ A}$ (Note 2) | | 0.82 | 1.3 | V |
| | | $V_{GS} = 0\text{ V}$, $I_S = 2\text{ A}$ (Note 2) | | 0.71 | 1.2 | |
| t_{rr} | Reverse Recovery Time | $I_F = 13.5\text{ A}$, $di/dt = 100\text{ A}/\mu\text{s}$ | | 38 | 62 | ns |
| Q_{rr} | Reverse Recovery Charge | | | 21 | 34 | nC |

NOTES:

- $R_{\theta JA}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



53 $^\circ\text{C/W}$ when mounted on a
1 in² pad of 2 oz copper



125 $^\circ\text{C/W}$ when mounted on
a minimum pad of 2 oz copper

- Pulse Test: Pulse Width < 300 μs , Duty cycle < 2.0%.
- Starting $T_J = 25\text{ }^\circ\text{C}$; N-ch: L = 0.3 mH, $I_{AS} = 23\text{ A}$, $V_{DD} = 54\text{ V}$, $V_{GS} = 10\text{ V}$.

Typical Characteristics $T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted

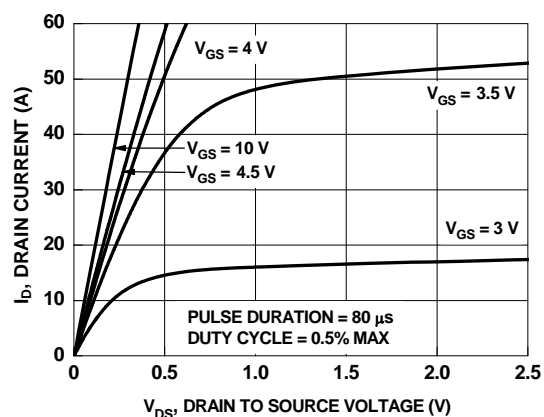


Figure 1. On Region Characteristics

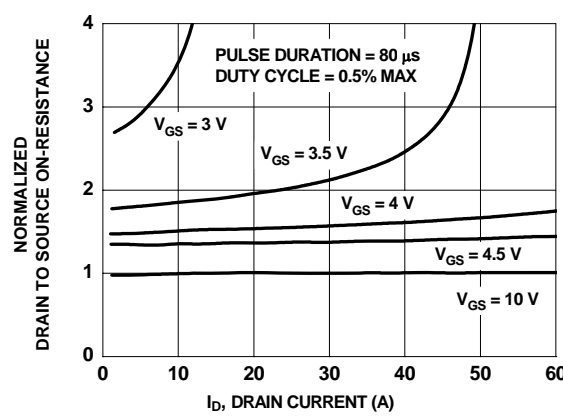


Figure 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

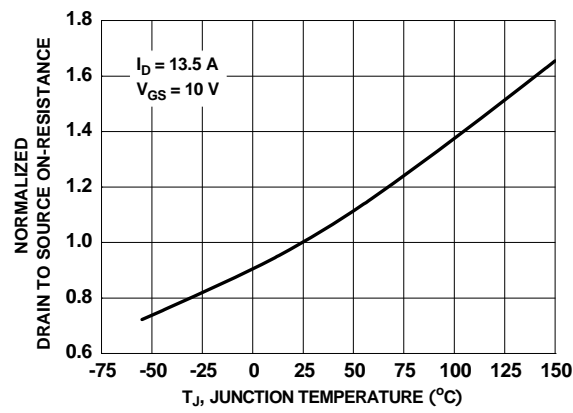


Figure 3. Normalized On Resistance vs. Junction Temperature

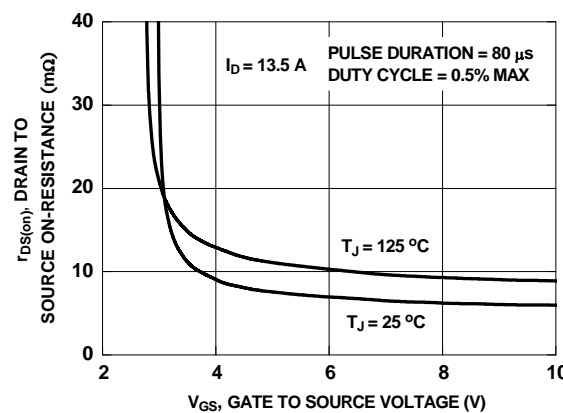


Figure 4. On-Resistance vs. Gate to Source Voltage

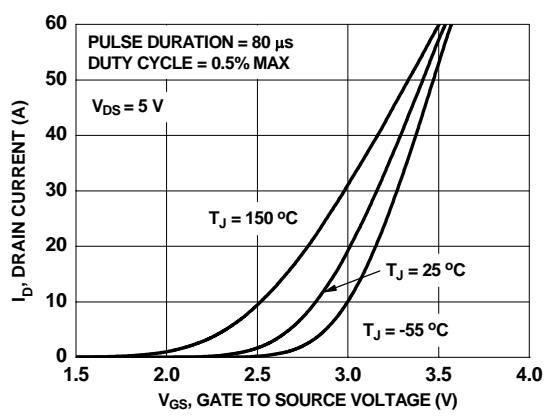


Figure 5. Transfer Characteristics

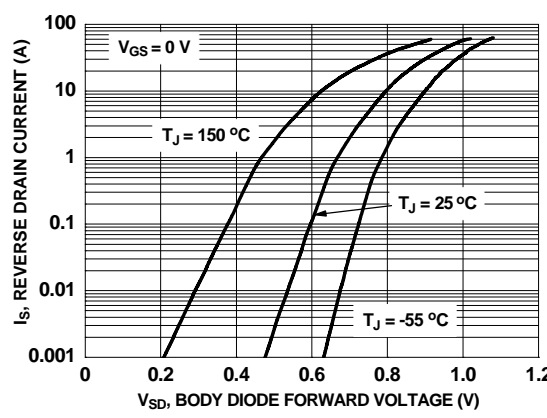


Figure 6. Source to Drain Diode Forward Voltage vs. Source Current

Typical Characteristics $T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted

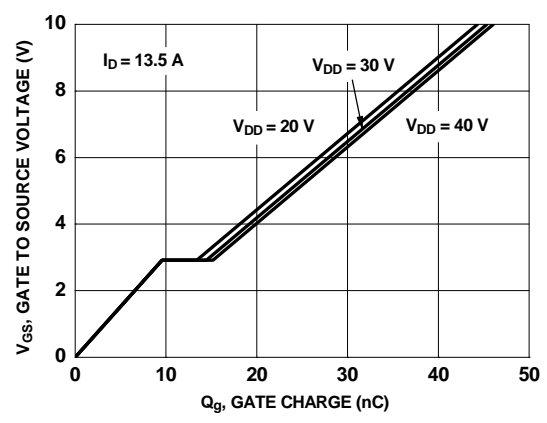


Figure 7. Gate Charge Characteristics

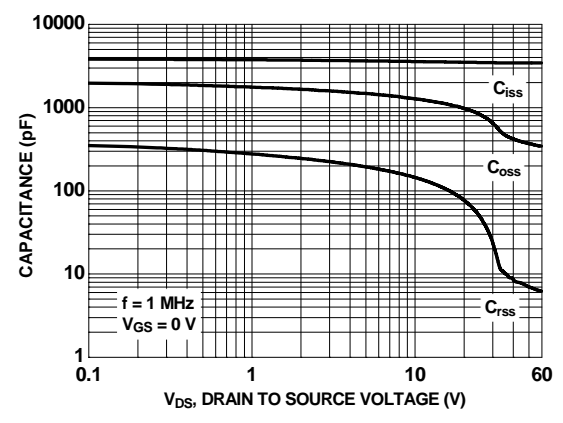


Figure 8. Capacitance vs. Drain to Source Voltage

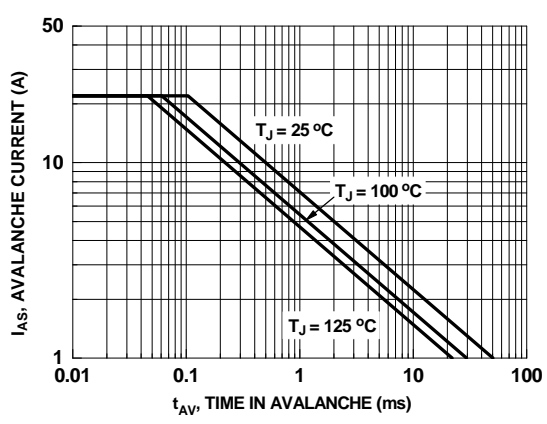


Figure 9. Unclamped Inductive Switching Capability

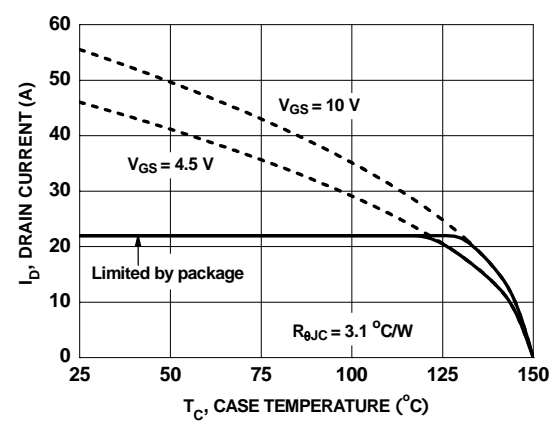


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

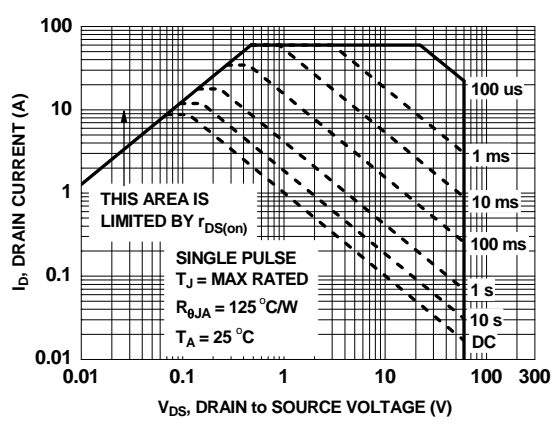


Figure 11. Forward Bias Safe Operating Area

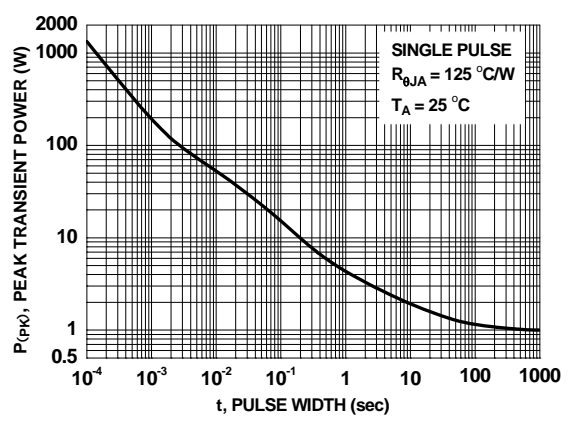


Figure 12. Single Pulse Maximum Power Dissipation

Typical Characteristics $T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted

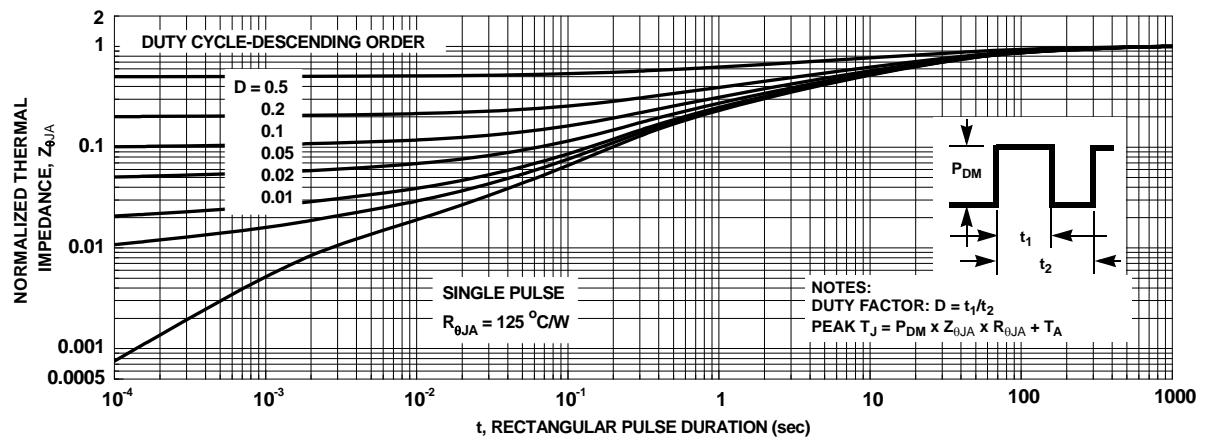


Figure 13. Junction-to-Ambient Transient Thermal Response Curve

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